

Features

 Transient protection for high-speed data lines IEC61000 -4-2 (ESD) ±15kV (Air)

±15kV (Alr) ±15kV (Contact) 5.0A (8/20µs)

IEC 61000-4-5 (Lightning)

- Cable Discharge Event (CDE)
- Array of surge rated diodes with internal TVS diode
- Small package saves board space
- Protects four I/O lines
- Low capacitance: 0.50pF@2.5V(Typical)(I/O-GND) 0.25pF@2.5V(Typical)(I/O-I/O)
- Low leakage current: 0.1µA@VRWM (Typical)
- Low clamping voltage
- Each I/O pin can withstand over 1000 ESD strikes for ±8kV contact discharge

Description

TT0534SPX is an ultra-low capacitance Transient Voltage Suppressor (TVS) designed to provide electrostatic discharge (ESD) protection for high-speed data interfaces. With typical capacitance of 0.5pF only, is designed to protect parasitic-sensitive systems against over-voltage and over-current transient events. It complies with IEC61000-4-2 (ESD), Level 4 (±15kV air, ±8kV contact discharge), IEC61000-4-5 (Lightning) (5A, 8/20us), very fast charged device model (CDM) ESD and cable discharge event (CDE),etc. The TT0534SPX comes in a RoHS compliant and Halogen Free 2.5mm x 1.0mm x 0. 55mm DFN2510-10L package. This device incorporates eight surge rated, ultra-low capacitance steering diodes and aTVS in a single package. Diveriste eramsie hodes not treas, the transient to either the positive side of the power supply line or to ground.



DFN2510-10L (Bottom View)

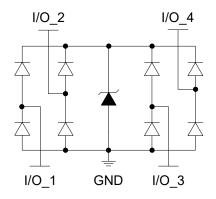
Applications

- HDMI 1.4/2.0, USB 3.0, MDDI, SATA ports
- Monitors and flat panel displays
- Set-top box
- Video graphics cards
- Digital Video Interface (DVI)
- Notebook computers

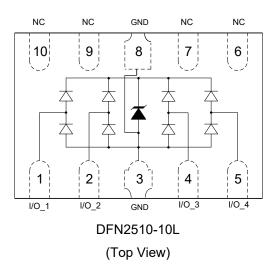
Mechanical Characteristics

- Package: DFN2510-10L
- Marking: Part number
- Packaging: Tape and Reel
- ROHS compliant

Circuit Diagram



Pin Configuration



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Absolute Maximum Rating

| Symbol | Parameter | Value | Units |
|------------------|--|------------|-------|
| I _{PP} | Peak Pulse Current (8/20µs) | 5 | А |
| P _{PK} | Peak Pulse Power (8/20µs) | 20 | W |
| V _{ESD} | ESD per IEC61000-4-2 (Air) ESD per IEC61000-4-2 (Contact) | ±15 ±15 | kV |
| T _{OPT} | Operating Temperature | -55/+125 | °C |
| T _{STG} | Storage Temperature | -55/+150 | ٥C |

Electrical Characteristics (T = 25°C)

| Symbol | Parameter | Diagram |
|------------------|--|-------------------|
| V _{RWM} | Nominal Reverse Working Voltage | ↑ ' |
| I _R | Reverse Leakage Current @ V _{RWM} | 1 _{PP} 7 |
| V_{BR} | Reverse Breakdown Voltage @ I_T | |
| Ι _Τ | Test Current for Reverse Breakdown | |
| Vc | Clamping Voltage @ I _{PP} | |
| I _{PP} | Maximum Peak Pulse Current | |
| C _{ESD} | Parasitic Capacitance | |
| ١ _F | Forward Current | |
| V _F | Forward Voltage @ I_F | |

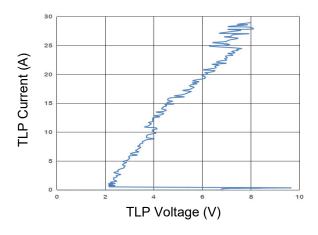
| Symbol | Test Condition | Minimum | Typical | Maximum | Units |
|------------------|--|---------|---------|---------|-------|
| V _{RWM} | | | | 5.0 | V |
| I _R | V _{RWM} = 5.0V, T = 25°C Between I/O and GND | | 0.1 | 1.0 | μA |
| V _{BR} | I _T = 1mA Between I/O and GND | 6.0 | 7.0 | | V |
| VC | I _{PP} = 5A, t _p = 8/20µs Between I/O and GND | | 3.5 | | V |
| Vc | $I_{PP} = 8.0A, t_p = 100ns^{(1)}$ | | 3.50 | | V |
| Ŭ | I _{PP} = 16.0A, t _p =100ns ⁽¹⁾ | | 5.20 | | V |
| R _{dyn} | I _{PP} = 12.0A, t _p = 100ns ⁽¹⁾ | | 0.22 | | Ω |
| C _{ESD} | V _R = 2.5V, f = 1MHz Between I/O and GND | | 0.50 | | pF |
| C _{ESD} | V _R = 2.5V, f = 1MHz Between I/O and I/O | | 0.25 | | pF |

Notes:(1)Measurements performed using a 100ns Transmission Line Pulse(TLP) system, Between I/O and GND.

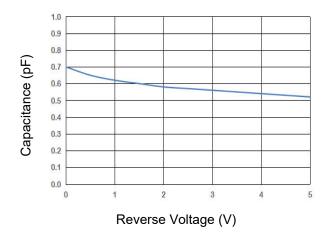


Typical Performance Characteristics

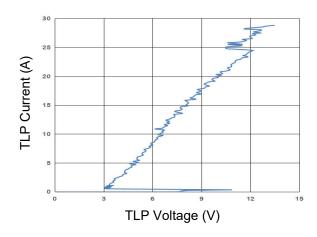
TLP Measurement of I/O to GND



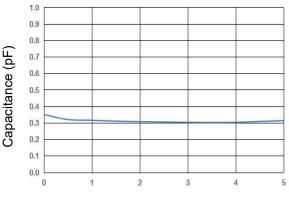
Capacitance vs Reverse Voltage IO to GND



TLP Measurement of I/O to I/O



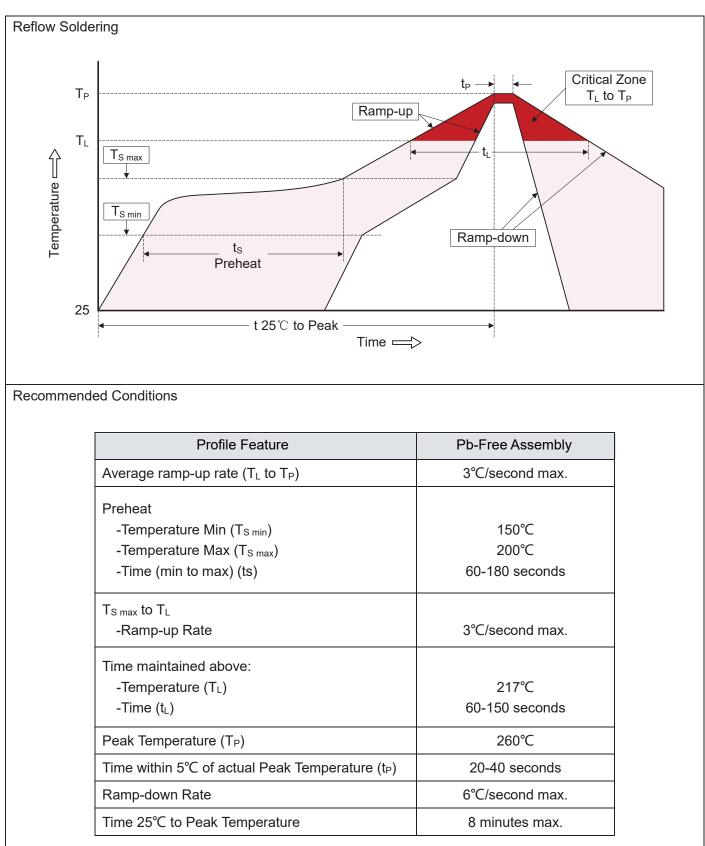
Capacitance vs Reverse Voltage IO to IO



Reverse Voltage (V)



Recommended Soldering Conditions





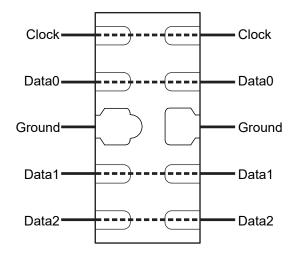
High Speed PCB Layout Guidelines

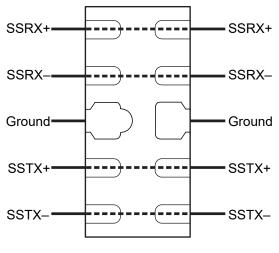
Printed circuit board layout is the key to achieving the highest level of surge immunity on power and data lines. The location of the protection devices on the PCB is the simplest and most important design rule to follow. The TT0534SPX devices should be located as close as possible to the noise source. The TT0534SPX device should be placed on all data and power lines that enter or exit the PCB at the I/O connector. In most systems, surge pulses occur on data and power lines that enter the PCB through the I/O connector. Placing the TT0534SPX devices as close as possible to the noise source ensures that a surge voltage will be clamped before the pulse can be coupled into adjacent PCB traces. In addition, the PCB should use the shortest possible traces. A short trace length equates to low impedance, which ensures that the surge energy will be dissipated by the TT0534SPX device. Long signal traces will act as antennas to receive energy from fields that are produced by the ESD pulse. By keeping line lengths as short as possible, the efficiency of the line to act as an antenna for ESD related fields is reduced. Minimize interconnecting line lengths by placing devices with the most interconnect as close together as possible. The protection circuits should shunt the surge voltage to either the reference or chassis ground. Shunting the surge voltage directly to the IC's signal ground can cause ground bounce. The clamping performance of TVS diodes on a single ground PCB can be improved by minimizing the impedance with relatively short and wide ground traces. The PCB layout and IC package parasitic inductances can cause significant overshoot to the TVS's clamping voltage. The inductance of the PCB can be reduced by using short trace lengths and multiple layers with separate ground and power planes. One effective method to minimize loop problems is to incorporate a ground plane in the PCB design.

The TT0534SPX ultra-low capacitance TVS is designed to protect four high speed data transmission lines from

transient over-voltages by clamping them to a fixed reference. The low inductance and construction minimizes voltage overshoot during high current surges. When the voltage on the protected line exceeds the reference voltage the

internal steering diodes are forward biased, conducting the transient current away from the sensitive circuitry. The TT0534SP is designed for ease of PCB layout by allowing the traces to run underneath the device. The pinout of the TT0534SP is designed to simply drop onto the IO lines of a High Definition Multimedia Interface (HDMI 1.4/2.0) or USB 3.0 design without having to divert the signal lines that may add more parasitic inductance. Pins 1, 2, 4 and 5 are connected to the internal TVS devices and pins 6, 7, 9 and 10 are no connects. The no connects was done so the package can be securely soldered onto the PCB surface.



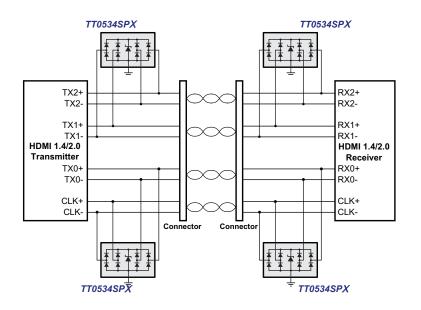


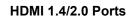
Flow Through Layout for HDMI 1.4/2.0

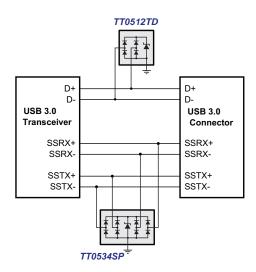
Flow Through Layout for USB 3.0



Application Information





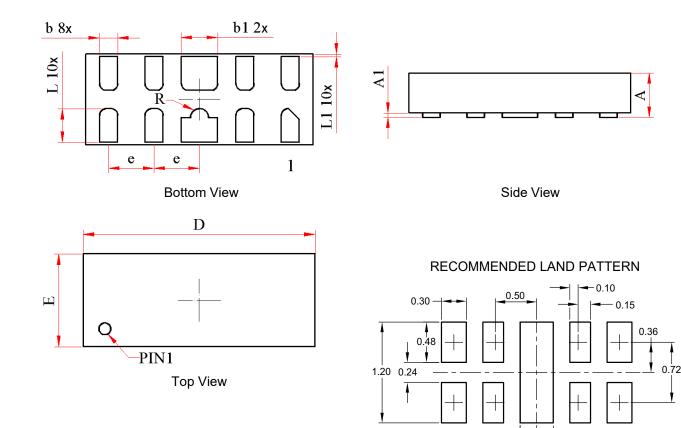




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Package Outline, DFN2510-10L



| Symbol | Dimensi | on In Mil | limeters | Dimension In Inches | | |
|--------|-----------|-----------|----------|----------------------------|-------|-------|
| | Normal | Min | Max | Normal | Min | Max |
| А | | 0.450 | 0.550 | | 0.018 | 0.026 |
| A1 | 0.050 | 0.025 | 0.075 | 0.002 | 0.001 | 0.003 |
| D | 2.500 | 2.450 | 2.550 | 0.098 | 0.096 | 0.100 |
| E | 1.000 | 0.950 | 1.050 | 0.039 | 0.037 | 0.041 |
| b | 0.200 | 0.150 | 0.250 | 0.008 | 0.006 | 0.010 |
| b1 | 0.400 | 0.350 | 0.450 | 0.016 | 0.014 | 0.018 |
| L | 0.370 | 0.320 | 0.420 | 0.015 | 0.013 | 0.017 |
| L1 | 0.030 | 0.000 | 0.060 | 0.001 | 0.000 | 0.002 |
| R | 0.100 REF | | | 0.004 REF | | |
| е | 0.500 BSC | | | 0.020 BSC | | |

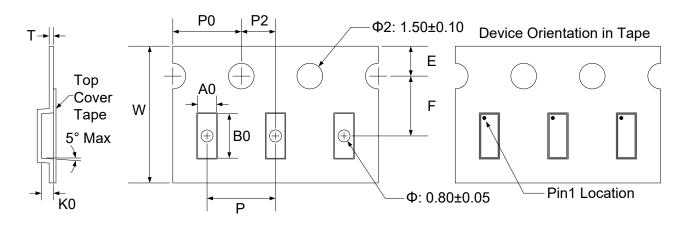
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0.40

0.20 -



Tape and Reel Specification



| Symbol | W | A0 | B0 | K0 | E | F | Ρ | P0 | P2 | Т |
|--------------------|------------------|-----------|----------|----------|----------|----------|---------|---------|----------|-----------|
| Dimensions (mm) | 8.00+0.3 -0.1 | 1.23±0.05 | 2.7±0.05 | 0.7±0.05 | 1.75±0.1 | 3.5±0.05 | 4.0±0.1 | 4.0±0.1 | 2.0±0.05 | 0.25±0.02 |

Marking Codes



Note:

- (1) "1" is part number, fixed.
- (2) "XXXXX" is the identification number.

Ordering Information

| Part Number | Working Voltage | Quantity Per Reel | Reel Size | |
|-------------------|--------------------|----------------------|-----------|--|
| TT0534SP X | 5.0V | 3,000 | 7 Inch | |

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